



www.txcorp.com

Press Announcement

Contact: sales@txcorp.com

Boulder, CO – September 27, 2010 – Tech-X Corporation invites you to visit us at the [63rd Gaseous Electronics Conference](#), **October 4 - 8**, in **Paris**.

We are proud to present the latest release of our electromagnetic plasma simulation software, [VORPAL](#). VORPAL 4.2 includes improved documentation, simplified installation on all platforms, additional collision models, import of user-defined secondary electron yield data, a new photoemission model, delta-F particles for modeling tokamak geometries, and new field updaters.

Stop by our booth to see a demonstration of any of these new features of VORPAL 4.2. Our staff will be happy to discuss the details of how VORPAL might fit your modeling needs.

Personnel from Tech-X will be presenting posters:

Christine Roark, Paul Mullaney, Kevin Paul, David Smithe, Peter Stoltz, "Simulating ECRH with VORPAL, a Particle-in-Cell Code, using Higher-Order Particles", during Poster Session II on Tuesday, October 5, 14:00 to 15:30